

MSKSEMI

SEMICONDUCTOR



ESD



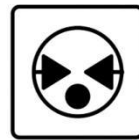
TVS



TSS



MOV



GDT



PLED

Product data sheet

产品简介

MAX810系列是一款具有电压检测功能的微处理器复位芯片,用于监控微控制器或其他逻辑系统的电源电压。它可以在上电掉电和节电情况下,向微控制器提供复位信号。当电源电压低于预设的检测电压时,器件会发出复位信号,直到电源电压又恢复到高于检测电压为止。

MAX810系列芯片当输入电压低于检测电压时, $\overline{V_{RESET}}$ 输出为高电平,应用简单,无需外部器件。

产品特点

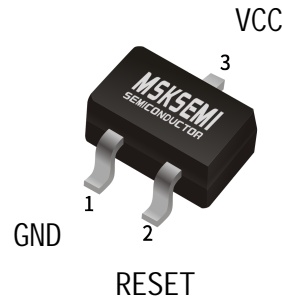
- 低功耗: 2uA (典型值)
- 宽工作电压范围: 1V~6.0V
- 具有 VCC 瞬态抗干扰
- 无需外部元件
- 内置复位延时时间 500ms (典型值)
- 高精度复位电压值: $\pm 2.5\%$
- 输入电压高于检测电压时, $\overline{V_{RESET}}$ 输出为低电平
- 小体积封装: SOT-23-3

产品用途

- 电池供电设备
- 无线通讯系统
- 电脑、微机处理器
- PAD和手持设备
- 嵌入式系统

封装形式和管脚定义功能

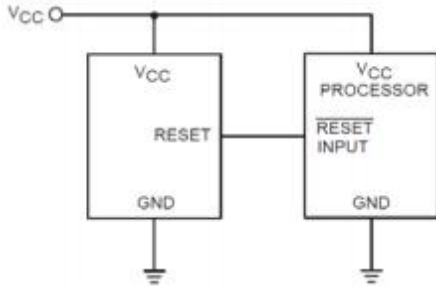
| 管脚序号 | 管脚定义 | 功能说明 |
|-------|--------------------|-------|
| SOT23 | | |
| 1 | GND | 芯片接地端 |
| 3 | VCC | 芯片输入端 |
| 2 | \overline{RESET} | 芯片输出端 |



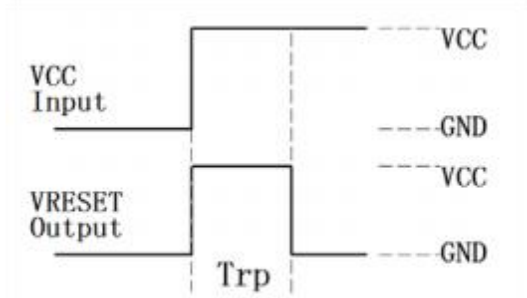
型号选择

| 名称 | 型号 | 最高输入电压(V) | 复位电压(Vth)V | 容差 | 封装形式 |
|------------------|---------|-----------|------------|-------------|----------|
| MAX810* *=VTH | MAX810L | 6.0 | 4.63 | $\pm 2.5\%$ | SOT-23-3 |
| | MAX810M | 6.0 | 4.38 | $\pm 2.5\%$ | |
| | MAX810T | 6.0 | 3.08 | $\pm 2.5\%$ | |
| | MAX810S | 6.0 | 2.93 | $\pm 2.5\%$ | |
| | MAX810R | 6.0 | 2.63 | $\pm 2.5\%$ | |
| | MAX810Z | 6.0 | 2.32 | $\pm 2.5\%$ | |

应用电路



上电复位时间



极限参数

| 项目 | 符号 | 说明 | 极限值 | 单位 |
|----|-------------|--------|------------------------|----|
| 电压 | V_{CC} | 输入电压 | 6.5 | V |
| | V_{RESET} | 复位输出电压 | $-0.3 \sim V_{CC}+0.3$ | V |
| 功耗 | PD | SOT23 | 200 | mW |
| 温度 | T_w | 工作温度范围 | -20—60 | °C |
| | T_c | 存储温度范围 | -50—125 | |
| | T_h | 焊接温度 | 260, 10s | °C |

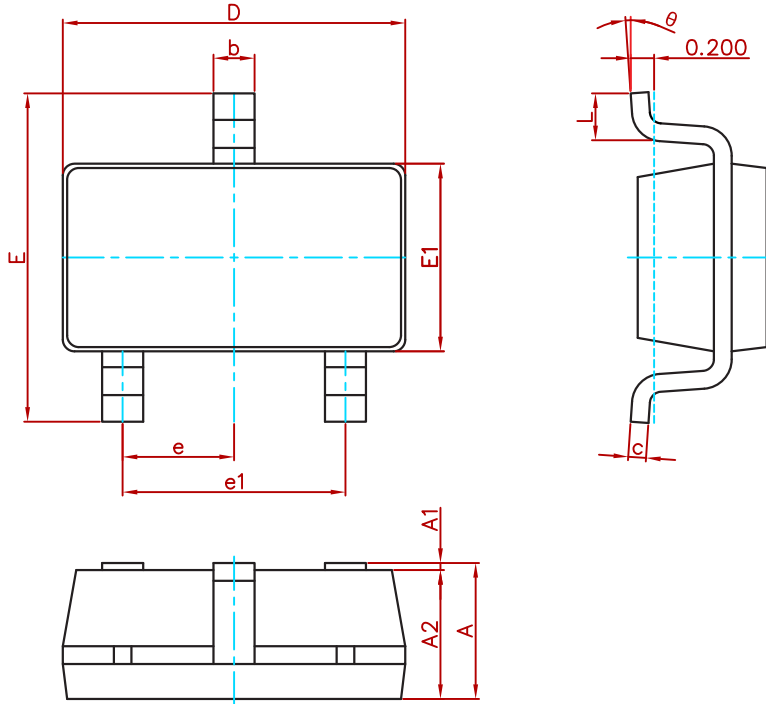
注：极限参数是指无论在任何条件下都不能超过的极限值。万一超过此极限值，将有可能造成产品劣化等物理性损伤；同时在接近极限参数下，不能保证芯片可以正常工作。

电学特性

MAX810 * $T_a=25^\circ\text{C}$

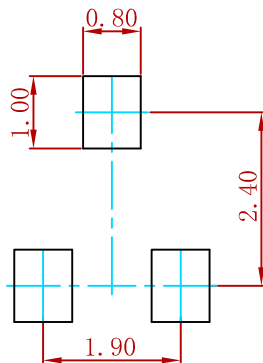
| 符号 | 参数 | 测试条件 | 最小 | 典型 | 最大 | 单位 | |
|---|---------|--|--|-----------|------------------|---------------|----|
| V_{CC} | 工作电压 | - | 1.0 | - | 6.0 | V | |
| I_{CC} | 静态电流 | $V_{CC}=5.5\text{V}, \text{No Load}$ | - | 2 | 5 | μA | |
| V_{th} | 检测电压 | V_{th} | $V_{th}*97.5\%$ | V_{th} | $V_{th}*102.5\%$ | V | |
| T_{rd} | 复位上升沿时间 | $V_{CC}=V_{th} \text{ to } (V_{th}-100\text{mV})$ | - | 90 | - | ns | |
| T_{rp} | 上电复位时间 | MAX10Z/R/S/T, $V_{CC}=0 \text{ to } 3.5\text{V}$ | $V_{RESET} = \text{H}$ to L, No Load | 85 | 500 | 900 | ms |
| | | MAX10M/L, $V_{CC}=0 \text{ to } 5.0\text{V}$ | | | | | |
| V_{OL} | 复位输出低电压 | $V_{CC} = V_{thmax}, I_{SINK}=1.2\text{mA}$ | - | - | 0.3 | V | |
| V_{OH} | 复位输出高电压 | $1.8\text{V} < V_{CC} < V_{thmin},$ $I_{SOURCE}=150\mu\text{A}$ | $0.8V_{CC}$ | - | - | V | |
| $\frac{\Delta V_{th}}{(V_{th}*\Delta T_a)}$ | 温度系数 | $-20^\circ\text{C} \leq T_a \leq 60^\circ\text{C}$ | - | ± 200 | - | ppm/°C | |

PACKAGE MECHANICAL DATA



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.050 | 1.250 | 0.041 | 0.049 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.820 | 3.020 | 0.111 | 0.119 |
| E1 | 1.500 | 1.700 | 0.059 | 0.067 |
| E | 2.650 | 2.950 | 0.104 | 0.116 |
| e | 0.950(BSC) | | 0.037(BSC) | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.300 | 0.600 | 0.012 | 0.024 |
| θ | 0° | 8° | 0° | 8° |

Suggested Pad Layout



Note:
1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05mm.
3. The pad layout is for reference purposes only.

REEL SPECIFICATION

| P/N | PKG | QTY |
|--------|----------|------|
| MAX810 | SOT-23-3 | 3000 |

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